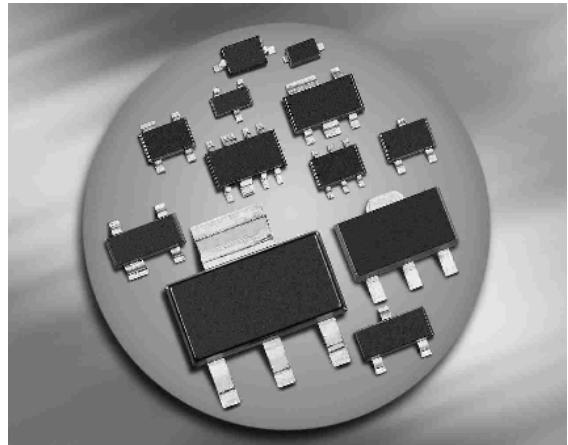


### PNP Silicon AF Transistor

- For AF input stages and driver applications
- High current gain
- Low collector-emitter saturation voltage
- Low noise between 30 hz and 15 kHz
- Complementary types:  
BC846...-BC850... (NPN)
- Pb-free (RoHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101



<sup>1</sup>Pb-containing package may be available upon special request

Type	Marking	Pin Configuration						Package
BC856A	3As	1=B	2=E	3=C	-	-	-	SOT23
BC856B	3Bs	1=B	2=E	3=C	-	-	-	SOT23
BC856BW	3Bs	1=B	2=E	3=C	-	-	-	SOT323
BC857A	3Es	1=B	2=E	3=C	-	-	-	SOT23
BC857B	3Fs	1=B	2=E	3=C	-	-	-	SOT23
BC857BF*	3Fs	1=B	2=E	3=C	-	-	-	TSFP-3
BC857BL3	3F	1=B	2=E	3=C	-	-	-	TSLP-3-1
BC857BW	3Fs	1=B	2=E	3=C	-	-	-	SOT323
BC857C	3Gs	1=B	2=E	3=C	-	-	-	SOT23
BC857CW	3Gs	1=B	2=E	3=C	-	-	-	SOT323
BC858A	3Js	1=B	2=E	3=C	-	-	-	SOT23
BC858B	3Ks	1=B	2=E	3=C	-	-	-	SOT23
BC858BL3	3K	1=B	2=E	3=C	-	-	-	TSLP-3-1
BC858BW	3Ks	1=B	2=E	3=C	-	-	-	SOT323
BC858C	3Ls	1=B	2=E	3=C	-	-	-	SOT23
BC858CW	3Ls	1=B	2=E	3=C	-	-	-	SOT323
BC859C	4Cs	1=B	2=E	3=C	-	-	-	SOT23
BC860B	4Fs	1=B	2=E	3=C	-	-	-	SOT23
BC860BW	4Fs	1=B	2=E	3=C	-	-	-	SOT323
BC860CW	4Gs	1=B	2=E	3=C	-	-	-	SOT323

\* Not for new design

**Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage BC856...	$V_{CEO}$	65	V
BC857..., BC860...		45	
BC858..., BC859...		30	
Collector-base voltage BC856...	$V_{CBO}$	80	
BC857..., BC860...		50	
BC858..., BC859...		30	
Emitter-base voltage	$V_{EBO}$	5	
Collector current	$I_C$	100	mA
Peak collector current, $t_p \leq 10$ ms	$I_{CM}$	200	
Total power dissipation $T_S \leq 71$ °C, BC856-BC860	$P_{tot}$	330	mW
$T_S \leq 128$ °C, BC857BF-BC858BF		250	
$T_S \leq 135$ °C, BC857BL3, BC860BL3		250	
$T_S \leq 124$ °C, BC856W-BC860W		250	
Junction temperature	$T_j$	150	°C
Storage temperature	$T_{stg}$	-65 ... 150	

**Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup> BC856-BC860	$R_{thJS}$	$\leq 240$	K/W
BC857BF-BC858BF			
BC857BL3, BC858BL3			
BC856W-BC860W			

<sup>1</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>DC Characteristics</b>					
Collector-emitter breakdown voltage $I_C = 10 \text{ mA}, I_B = 0$ , BC856...	$V_{(\text{BR})\text{CEO}}$	65	-	-	V
$I_C = 10 \text{ mA}, I_B = 0$ , BC857..., BC860...		45	-	-	
$I_C = 10 \text{ mA}, I_B = 0$ , BC858..., BC859...		30	-	-	
Collector-base breakdown voltage $I_C = 10 \mu\text{A}, I_E = 0$ , BC856...	$V_{(\text{BR})\text{CBO}}$	80	-	-	
$I_C = 10 \mu\text{A}, I_E = 0$ , BC857..., BC860...		50	-	-	
$I_C = 10 \mu\text{A}, I_E = 0$ , BC858..., BC859...		30	-	-	
Emitter-base breakdown voltage $I_E = 1 \mu\text{A}, I_C = 0$	$V_{(\text{BR})\text{EBO}}$	5	-	-	
Collector-base cutoff current $V_{CB} = 45 \text{ V}, I_E = 0$ $V_{CB} = 30 \text{ V}, I_E = 0, T_A = 150^\circ\text{C}$	$I_{\text{CBO}}$	-	-	0.015 5	$\mu\text{A}$
DC current gain <sup>1)</sup> $I_C = 10 \mu\text{A}, V_{CE} = 5 \text{ V}, h_{FE}\text{-grp.A}$ $I_C = 10 \mu\text{A}, V_{CE} = 5 \text{ V}, h_{FE}\text{-grp.B}$ $I_C = 10 \mu\text{A}, V_{CE} = 5 \text{ V}, h_{FE}\text{-grp.C}$ $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, h_{FE}\text{-grp.A}$ $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, h_{FE}\text{-grp.B}$ $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, h_{FE}\text{-grp.C}$	$h_{FE}$	- - - 125 220 420	140 250 480 180 290 520	- - - 250 475 800	-
Collector-emitter saturation voltage <sup>1)</sup> $I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$ $I_C = 100 \text{ mA}, I_B = 5 \text{ mA}$	$V_{CE\text{sat}}$	- -	75 250	300 650	mV
Base emitter saturation voltage <sup>1)</sup> $I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$ $I_C = 100 \text{ mA}, I_B = 5 \text{ mA}$	$V_{BE\text{sat}}$	- -	700 850	- -	
Base-emitter voltage <sup>1)</sup> $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}$ $I_C = 10 \text{ mA}, V_{CE} = 5 \text{ V}$	$V_{BE(\text{ON})}$	600 -	650 -	750 820	

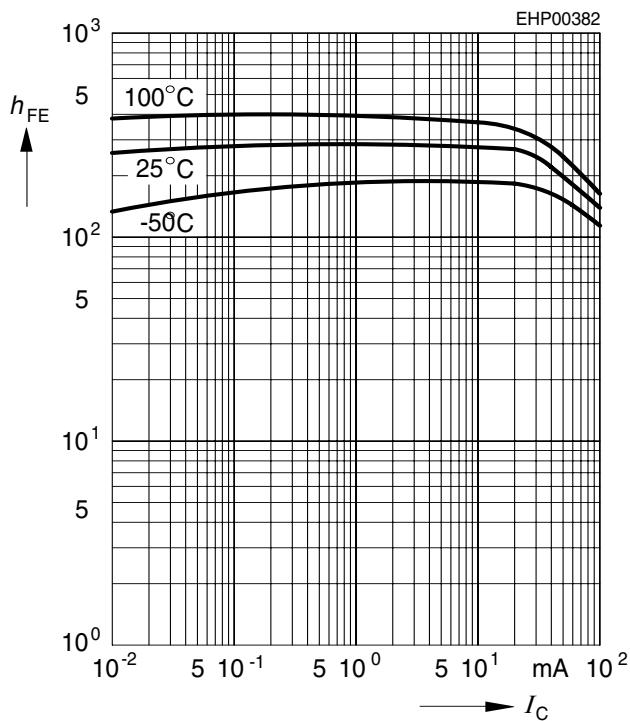
<sup>1</sup>Pulse test:  $t < 300\mu\text{s}$ ;  $D < 2\%$

**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>AC Characteristics</b>					
Transition frequency $I_C = 20 \text{ mA}, V_{CE} = 5 \text{ V}, f = 100 \text{ MHz}$	$f_T$	-	250	-	MHz
Collector-base capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$	$C_{cb}$	-	1.5	-	pF
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}$	$C_{eb}$	-	8	-	
Short-circuit input impedance $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz}, h_{FE}-\text{grp.A}$ $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz}, h_{FE}-\text{grp.B}$ $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz}, h_{FE}-\text{grp.C}$	$h_{11e}$	-	2.7	-	kΩ
Open-circuit reverse voltage transf. ratio $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz}, h_{FE}-\text{grp.A}$ $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz}, h_{FE}-\text{grp.B}$ $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz}, h_{FE}-\text{grp.C}$	$h_{12e}$	-	1.5	-	$10^{-4}$
Short-circuit forward current transf. ratio $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz}, h_{FE}-\text{grp.A}$ $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz}, h_{FE}-\text{grp.B}$ $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz}, h_{FE}-\text{grp.C}$	$h_{21e}$	-	200	-	-
Open-circuit output admittance $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz}, h_{FE}-\text{grp.A}$ $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz}, h_{FE}-\text{grp.B}$ $I_C = 2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz}, h_{FE}-\text{grp.C}$	$h_{22e}$	-	18	-	μS
Noise figure $I_C = 0.2 \text{ mA}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz},$ <b>D f = 200 Hz, <math>R_S = 2 \text{ kΩ}</math>, BC859, BC850</b>	$F$	-	1	4	dB
Equivalent noise voltage $I_C = 200 \text{ mA}, V_{CE} = 5 \text{ V}, R_S = 2 \text{ kΩ},$ $f = 10 \dots 50 \text{ Hz}, \text{BC860}$	$V_n$	-	-	0.11	μV

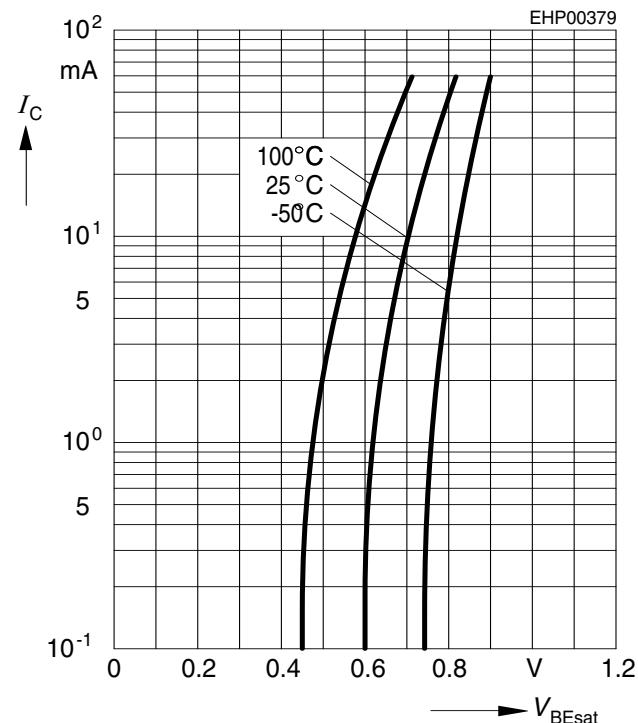
**DC current gain  $h_{FE} = f(I_C)$**

$V_{CE} = 1 \text{ V}$



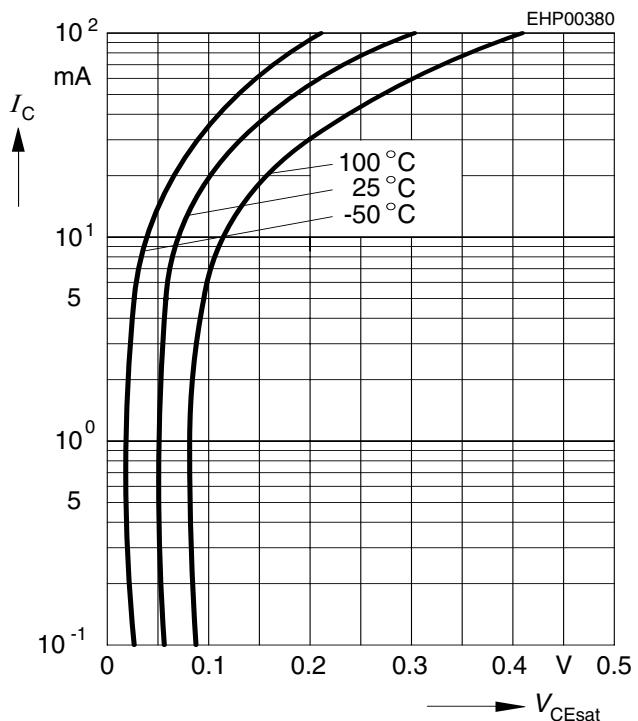
**Base-emitter saturation voltage**

$I_C = f(V_{BEsat}), h_{FE} = 20$



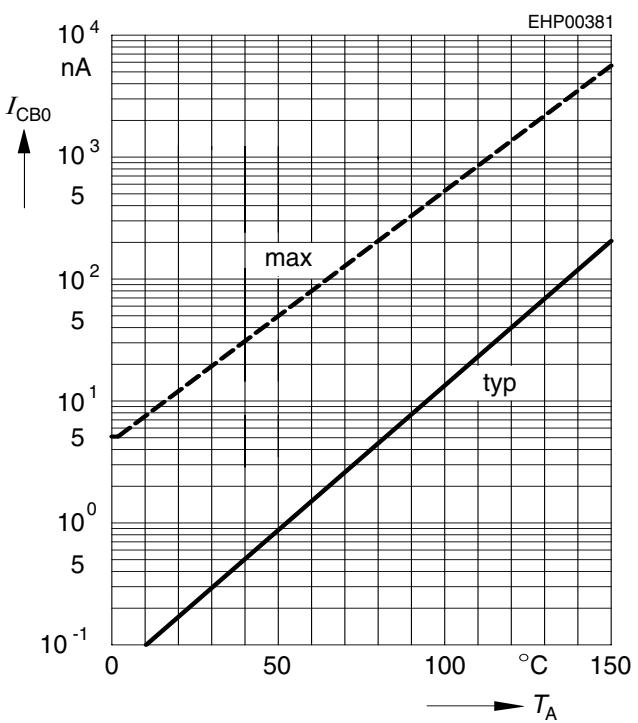
**Collector-emitter saturation voltage**

$I_C = f(V_{CEsat}), h_{FE} = 20$



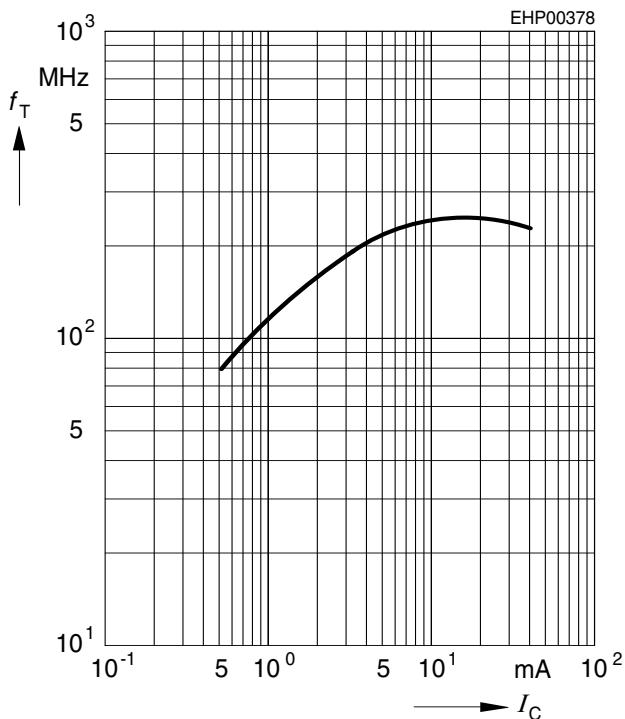
**Collector cutoff current  $I_{CBO} = f(T_A)$**

$V_{CBO} = 30 \text{ V}$



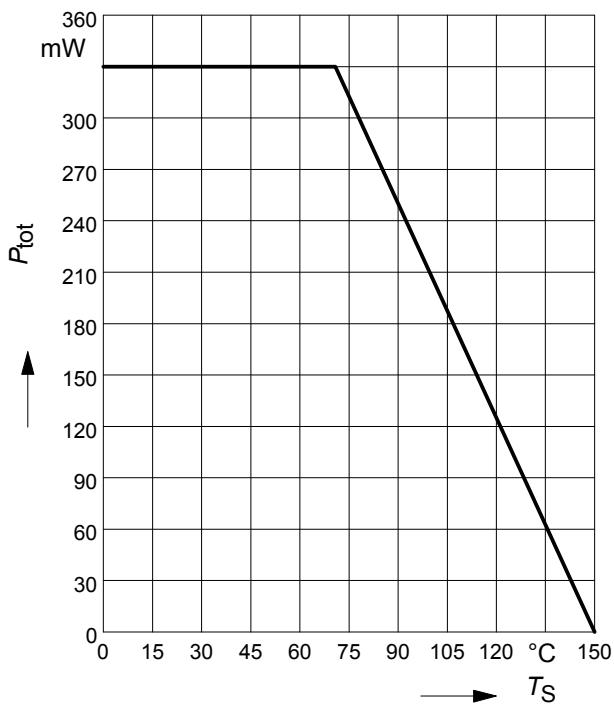
**Transition frequency**  $f_T = f(I_C)$

$V_{CE} = 5 \text{ V}$



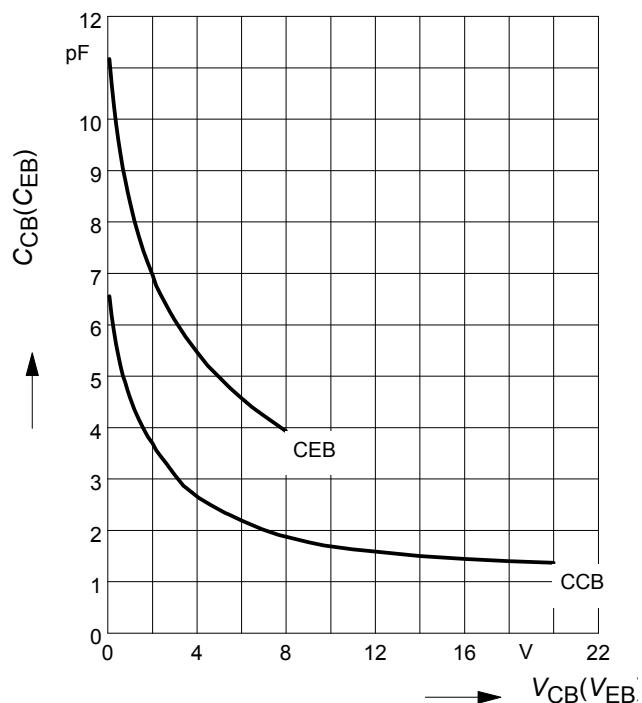
**Total power dissipation**  $P_{\text{tot}} = f(T_S)$

BC856-BC860



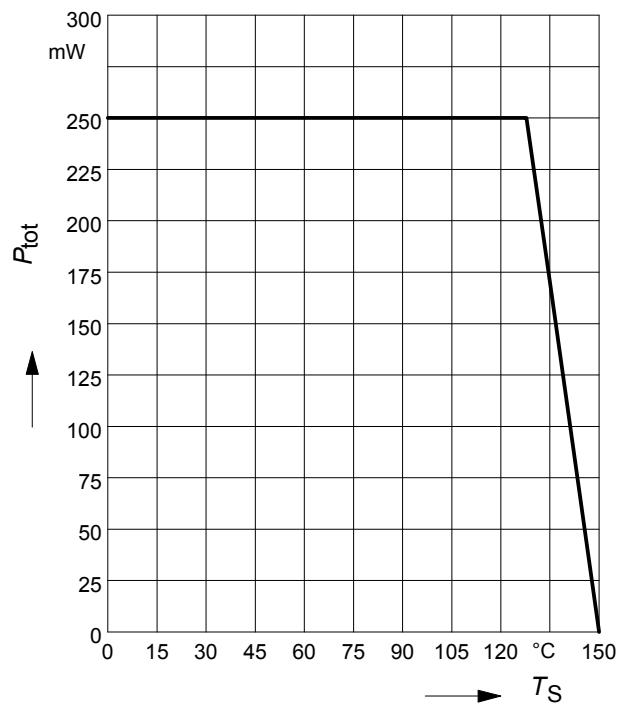
**Collector-base capacitance**  $C_{cb} = f(V_{CB})$

**Emitter-base capacitance**  $C_{eb} = f(V_{EB})$

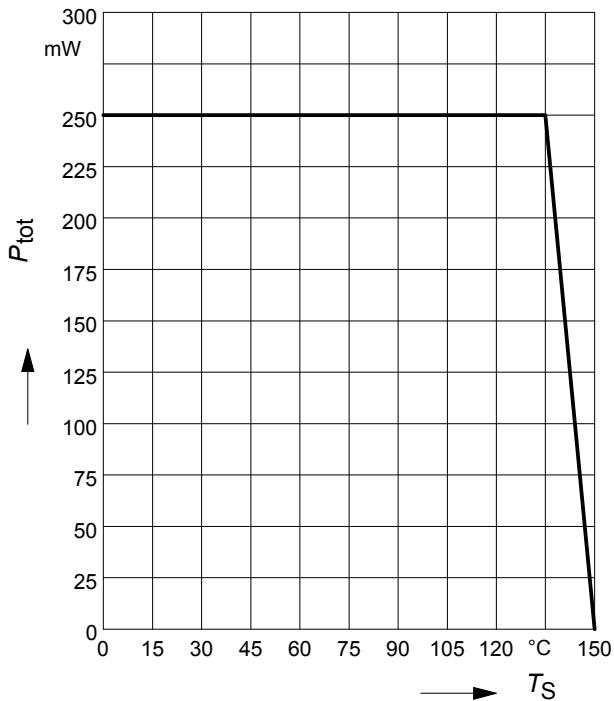


**Total power dissipation**  $P_{\text{tot}} = f(T_S)$

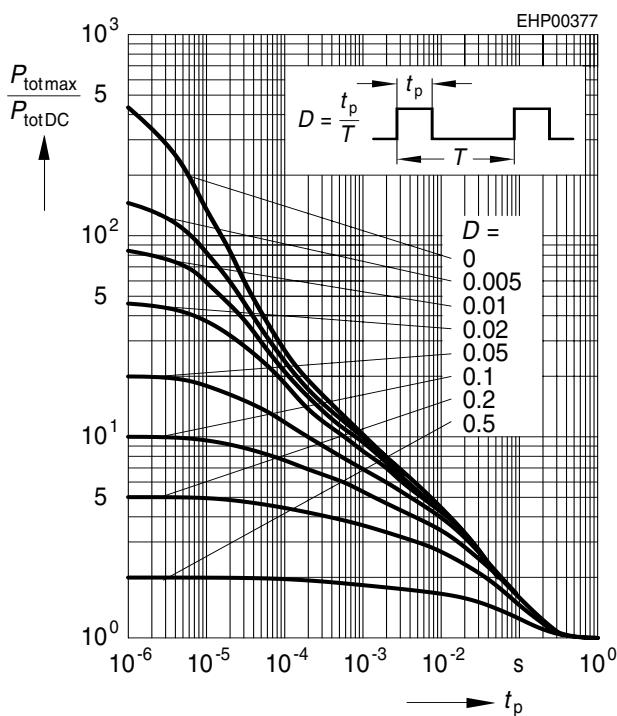
BC857BF, BC858BF



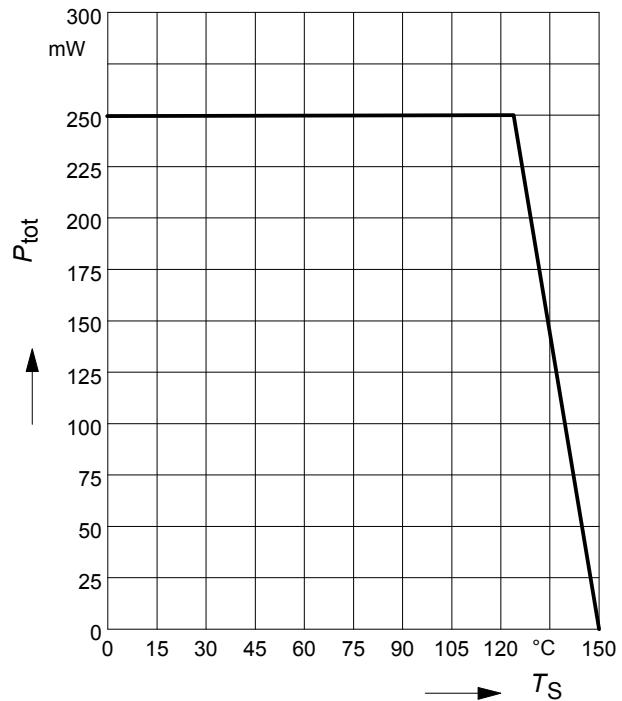
**Total power dissipation  $P_{\text{tot}} = f(T_S)$**   
BC857BL3, BC858BL3



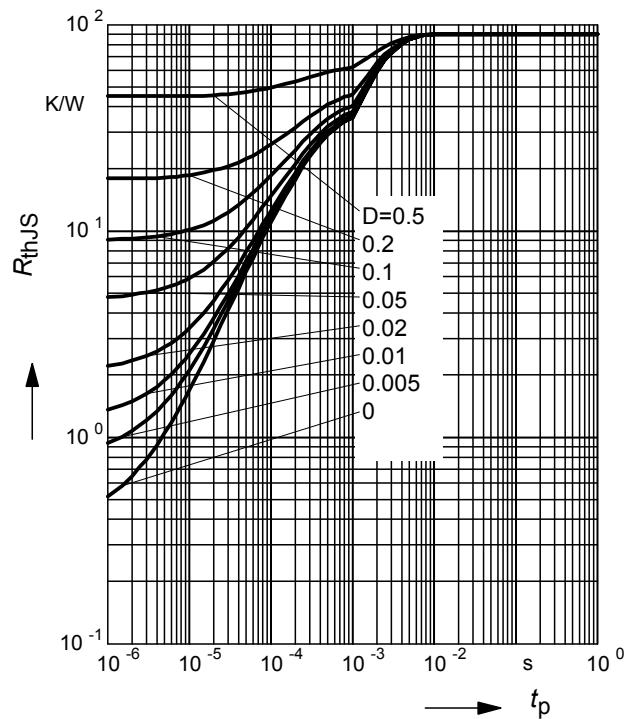
**Permissible Pulse Load**  
 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$   
BC856/W-BC860/W



**Total power dissipation  $P_{\text{tot}} = f(T_S)$**   
BC856W-BC860W



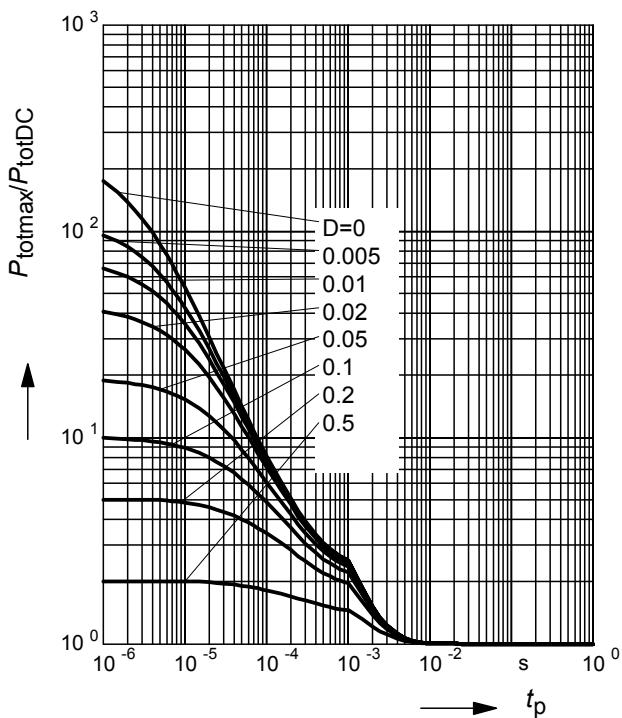
**Permissible Puls Load  $R_{\text{thJS}} = f(t_p)$**   
BC857BF, BC858BF



### Permissible Pulse Load

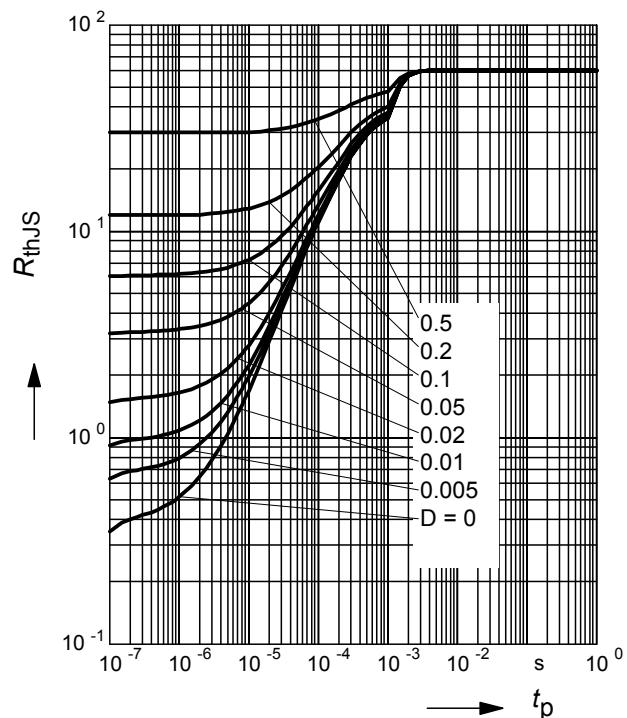
$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$

BC857BF, BC858BF



### Permissible Puls Load $R_{\text{thJS}} = f(t_p)$

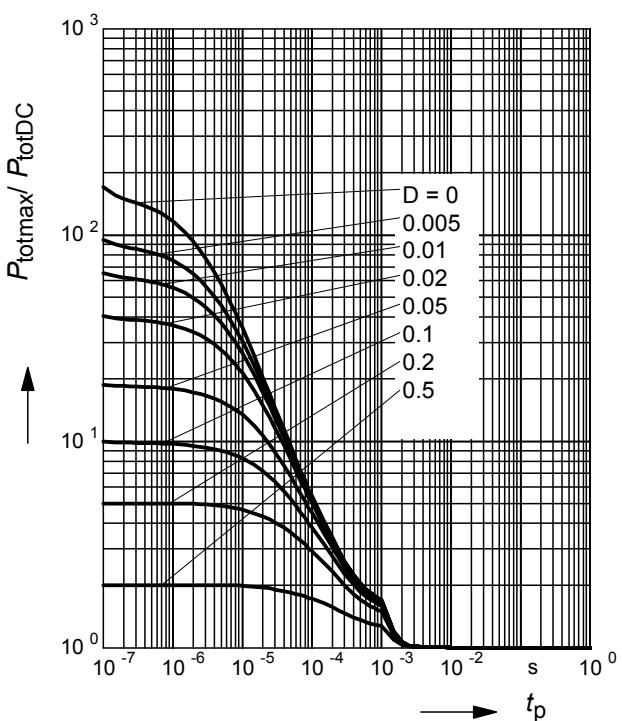
BC857BL3, BC858BL3



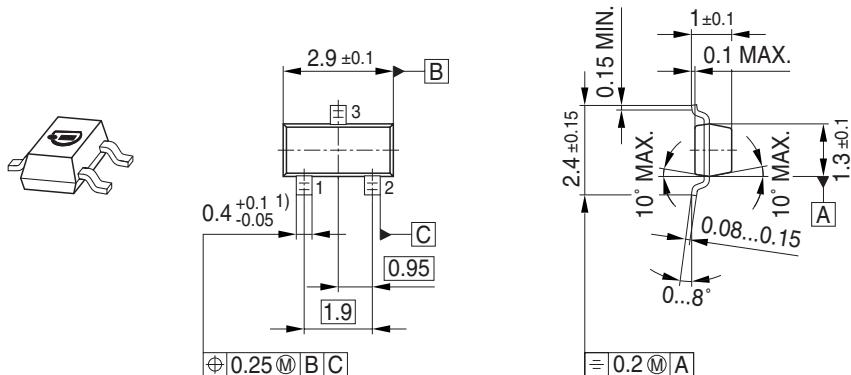
### Permissible Pulse Load

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$

BC857BL3, BC858BL3

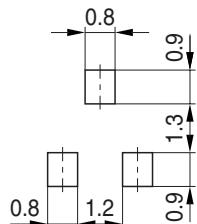


## Package Outline

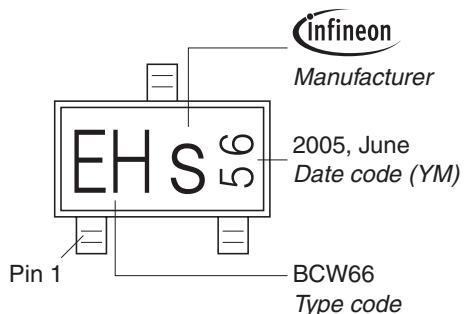


1) Lead width can be 0.6 max. in dambar area

## Foot Print

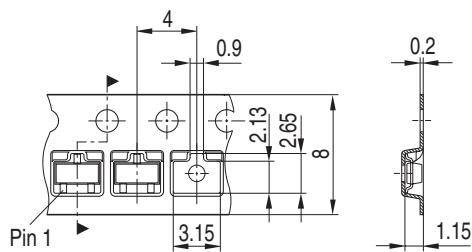


## Marking Layout (Example)

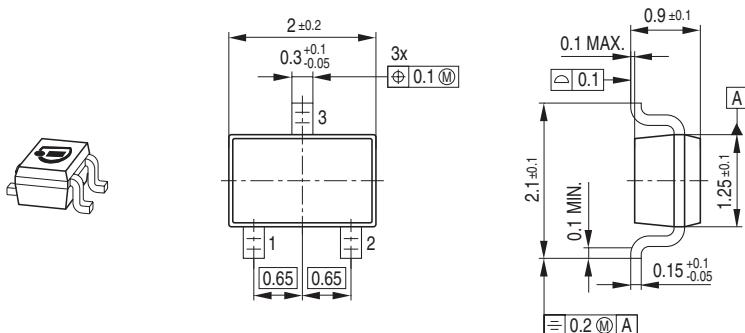


## Standard Packing

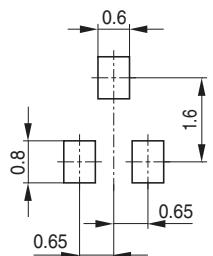
Reel ø180 mm = 3.000 Pieces/Reel  
Reel ø330 mm = 10.000 Pieces/Reel



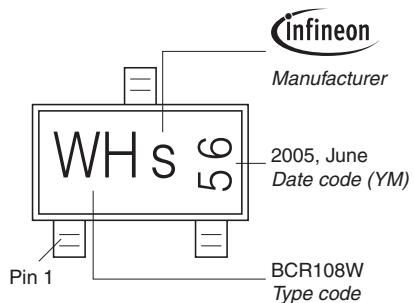
## Package Outline



## Foot Print

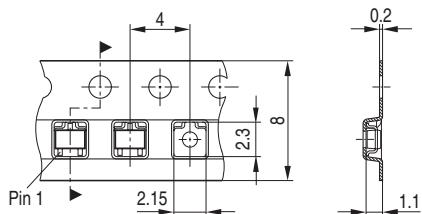


## Marking Layout (Example)

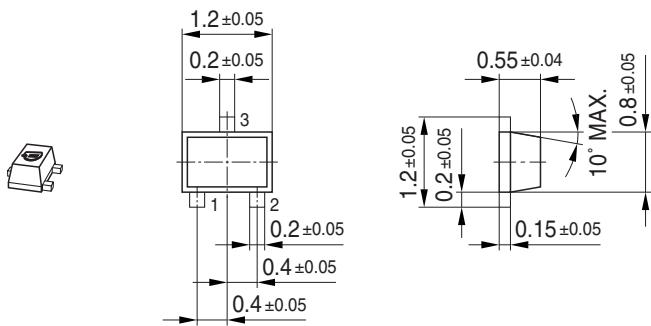


## Standard Packing

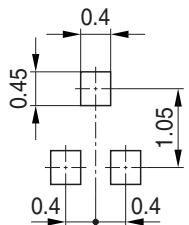
Reel ø180 mm = 3.000 Pieces/Reel  
Reel ø330 mm = 10.000 Pieces/Reel



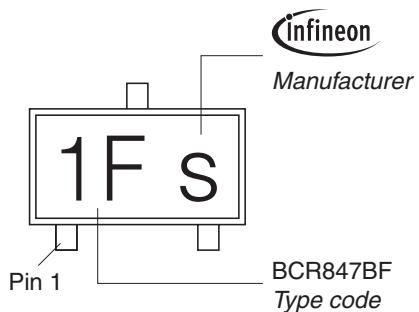
## Package Outline



## Foot Print

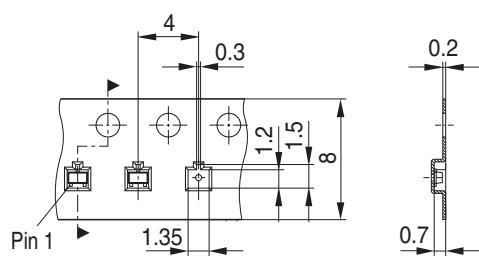


## Marking Layout (Example)

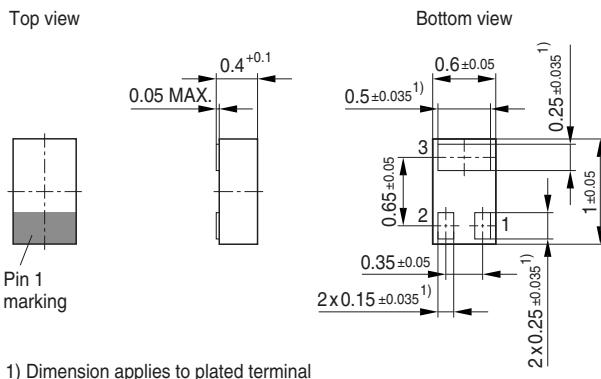


## Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel  
 Reel ø330 mm = 10.000 Pieces/Reel

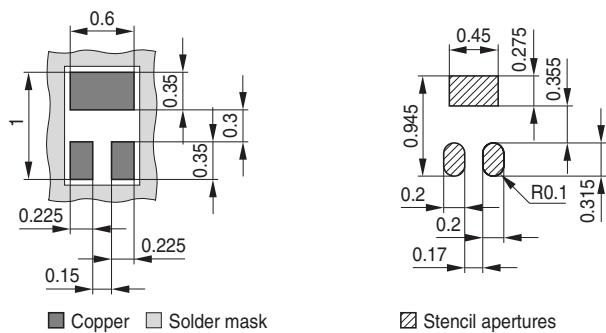


## Package Outline

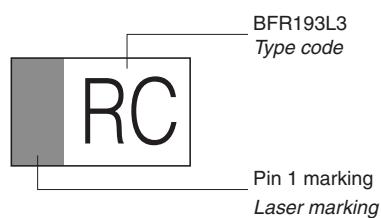


## Foot Print

For board assembly information please refer to Infineon website "Packages"

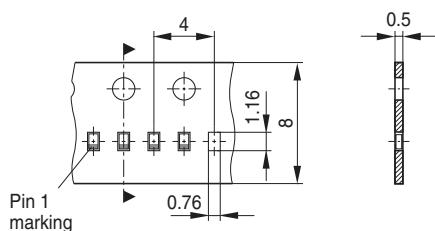


## Marking Layout (Example)



## Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel



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